

Single N-channel MOSFET

ELM16408EA-S

■General description

ELM16408EA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 1.8V and internal ESD protection is included.

■Features

- $V_{ds}=20V$
- $I_d=8.8A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 18m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 20m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 25m\Omega$ ($V_{gs}=2.5V$)
- $R_{ds(on)} < 32m\Omega$ ($V_{gs}=1.8V$)
- ESD Rating : 2000V HBM

■Maximum absolute ratings

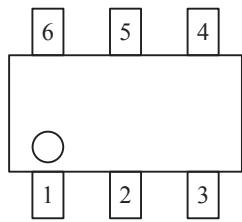
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	20	V	
Gate-source voltage	V_{gs}	± 12	V	
Continuous drain current	I_d	8.8	A	1
		7.0		
Pulsed drain current	I_{dm}	40	A	2
Power dissipation	P_d	2.00	W	
		1.28		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	47.5	62.5	°C/W	1
Maximum junction-to-ambient		74.0	110.0	°C/W	
Maximum junction-to-lead	$R_{\theta jl}$	37.0	40.0	°C/W	3

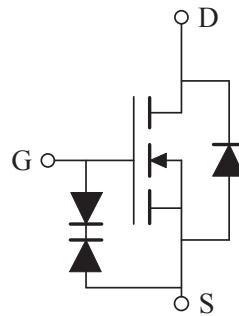
■Pin configuration

SOT-26(TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit	
STATIC PARAMETERS								
Drain-source breakdown voltage	BV _{dss}	Id=250μA, V _{gs} =0V		20			V	
Zero gate voltage drain current	Id _{ss}	V _{ds} =16V, V _{gs} =0V	T _j =55°C			10	μA	
						25		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±10V				±10	μA	
Gate-source breakdown voltage	BV _{gso}	V _{ds} =0V, I _g =±250μA		±12			V	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , Id=250μA		0.50	0.75	1.00	V	
On state drain current	Id(on)	V _{gs} =4.5V, V _{ds} =5V		40			A	
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =10V, Id=8.8A	T _j =125°C		14.4	18.0	mΩ	
					18.5	23.0		
		V _{gs} =4.5V, Id=8A			16.0	20.0	mΩ	
		V _{gs} =2.5V, Id=6A			20.5	25.0	mΩ	
		V _{gs} =1.8V, Id=4A			25.6	32.0	mΩ	
Forward transconductance	G _{fs}	V _{ds} =5V, Id=8.8A			33		S	
Diode forward voltage	V _{sd}	Is=1A			0.72	1.00	V	
Max. body-diode continuous current	Is					3	A	
DYNAMIC PARAMETERS								
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =10V, f=1MHz			1810	2200	pF	
Output capacitance	C _{oss}				232		pF	
Reverse transfer capacitance	C _{rss}				200		pF	
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz			1.6	2.2	Ω	
SWITCHING PARAMETERS								
Total gate charge	Q _g	V _{gs} =4.5V, V _{ds} =10V, Id=8.8A			17.9	22.0	nC	
Gate-source charge	Q _{gs}				1.5		nC	
Gate-drain charge	Q _{gd}				4.7		nC	
Turn-on delay time	t _{d(on)}	V _{gs} =10V, V _{ds} =10V R _l =1.1Ω, R _{gen} =3Ω			3.3		ns	
Turn-on rise time	t _r				5.9		ns	
Turn-off delay time	t _{d(off)}				44.0		ns	
Turn-off fall time	t _f				7.7		ns	
Body diode reverse recovery time	t _{rr}				22.0	27.0	ns	
Body diode reverse recovery charge	Q _{rr}	I _f =8.8A, dI/dt=100A/μs			9.8		nC	

NOTE :

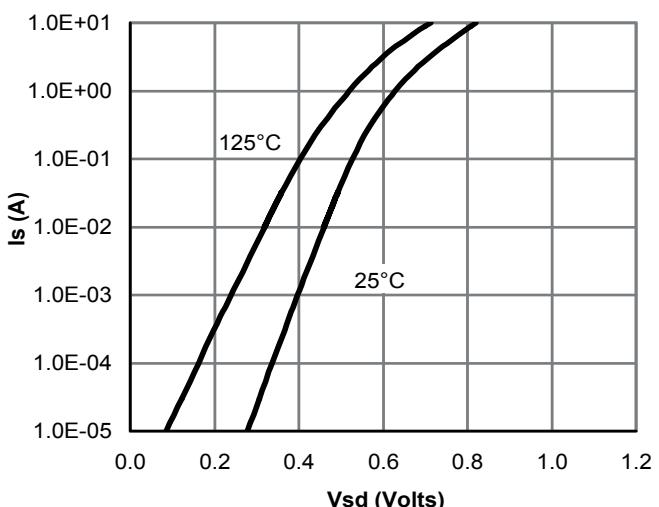
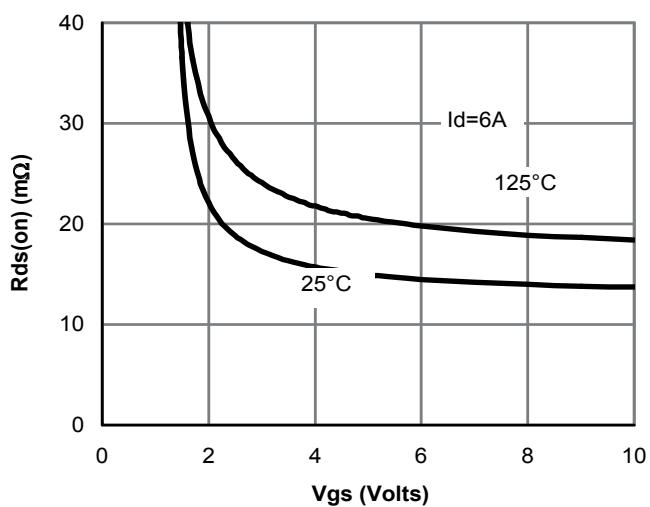
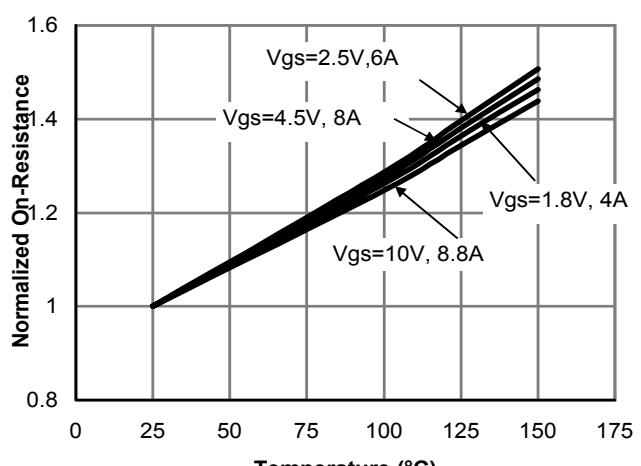
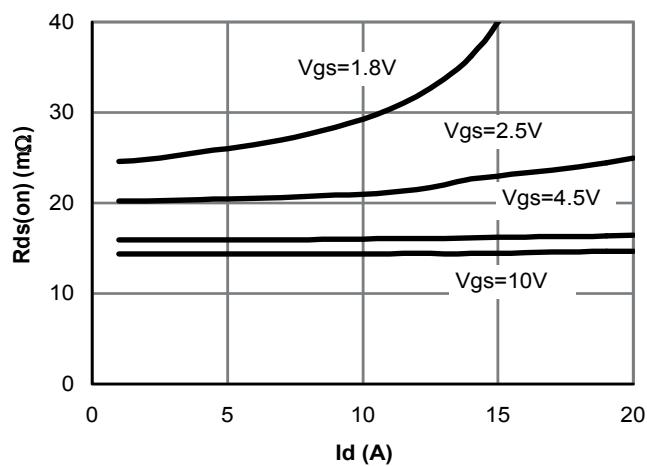
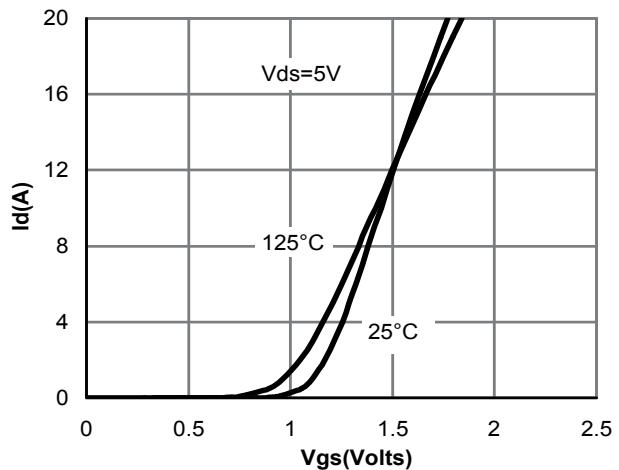
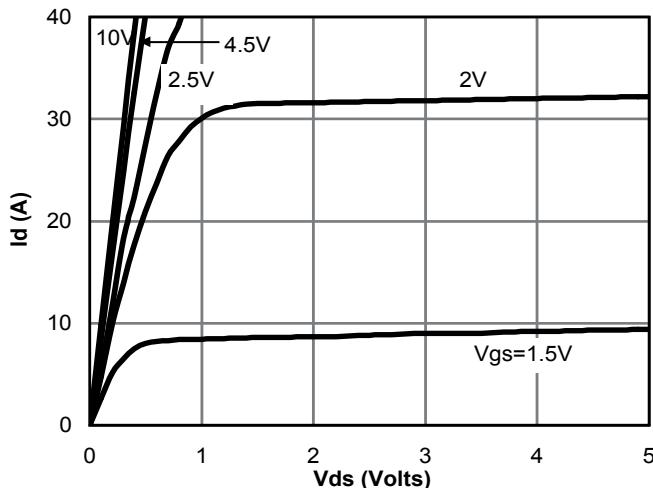
- The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics



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